

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6901343

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KHANDKER NAZRUL QUADER	01/30/2019
ROBERT NORMAN	01/30/2019
FRANK SAI-KEUNG LEE	01/30/2019
CHRISTOPHER J. PETTI	05/13/2019
SCOTT BRAD HERNER	05/10/2019
SIU LUNG CHAN	01/30/2019
SAYEEF SALAHUDDIN	01/30/2019
MEHRDAD MOFIDI	01/30/2019
ELI HARARI	01/30/2019
RECEIVING PARTY DATA	
Name:	SUNRISE MEMORY CORPORATION
Street Address:	225 CHARCOT AVENUE
City:	SAN JOSE
State/Country:	CALIFORNIA
Postal Code:	95131
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17467011
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4086205501
Email:	patents@vlpawgroup.com
Correspondent Name:	VLP LAW GROUP, LLP
Address Line 1:	555 BRYANT STREET SUITE 820
Address Line 4:	PALO ALTO, UNITED STATES 94301
ATTORNEY DOCKET NUMBER:	SRM-023 US C1
NAME OF SUBMITTER:	ANGELA WENDEL

SIGNATURE:	/angela wendel/
DATE SIGNED:	09/03/2021
Total Attachments: 16 source=20190130_SRM-023 US V1_TPO_Assignments_signed#page1.tif source=20190130_SRM-023 US V1_TPO_Assignments_signed#page2.tif source=20190130_SRM-023 US V1_TPO_Assignments_signed#page3.tif source=20190130_SRM-023 US V1_TPO_Assignments_signed#page4.tif source=20190130_SRM-023 US V1_TPO_Assignments_signed#page5.tif source=20190130_SRM-023 US V1_TPO_Assignments_signed#page6.tif source=20190130_SRM-023 US V1_TPO_Assignments_signed#page7.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page1.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page2.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page3.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page4.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page5.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page6.tif source=20190215_SRM_023_US_V2_TPO_Assignments_signed#page7.tif source=20190514_SRM 023_US_V3_TPO_assignments signed#page1.tif source=20190514_SRM 023_US_V3_TPO_assignments signed#page2.tif	

ASSIGNMENT

I, Eli HARARI, residing at Saratoga, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

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I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith, and generally do everything possible and necessary to perfect all rights, title and interest hereby assigned and transferred, and hereby agreed to be assigned and transferred, in and to Assignee.


Eli HARARI

1.30.19
Date

For and on behalf of Sunrise Memory Corporation


Signature

1/30/19
Date

Name: NOAM KEDEM
Title: operations


ASSIGNMENT

I, Robert Norman, residing at Pendleton, Oregon, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

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Robert Norman

Jan 30, 2019
Date

For and on behalf of Sunrise Memory Corporation


Signature

1/30/2019
Date

Name: NOAM KEDM
Title: Operations


ASSIGNMENT

I, Sayeef Salahuddin, residing at Walnut Creek, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

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Sayeef Salahuddin

1.30.2019
Date

For and on behalf of Sunrise Memory Corporation


Signature

1/30/2019
Date

Name: NOAM KEDEM
Title: OPERATIONS

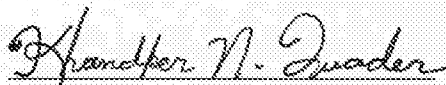
ASSIGNMENT

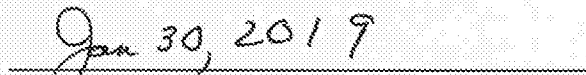
I, Khandker Nazrul Quader, residing at Santa Clara, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

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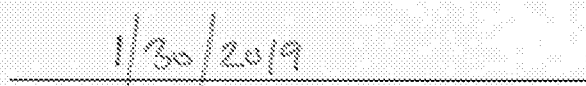
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Khandker Nazrul Quader


Date

For and on behalf of Sunrise Memory Corporation


Signature


Date

Name: NOAM KEDEM
Title: Operations

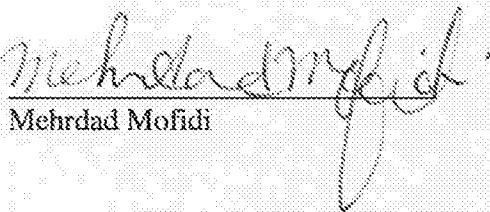
ASSIGNMENT

I, Mehrdad Mofidi, residing at Los Altos Hills, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

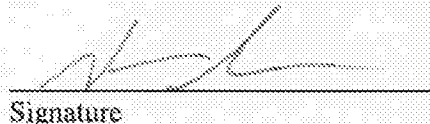
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Mehrdad Mofidi

1/30/2019
Date

For and on behalf of Sunrise Memory Corporation


Signature

1/30/2019
Date

Name: NOAM KEDEM
Title: OPERATIONS

ASSIGNMENT

I, Siu Lung Chan, residing at San Jose, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

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Siu Lung Chan

1/30/19

Date

For and on behalf of Sunrise Memory Corporation



Signature

1/30/19

Date

Name: NOAM KEDEM
Title: Operations

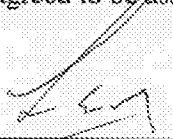
ASSIGNMENT

I, Frank Sai-keung Lee, residing at San Jose, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/798,673, filed January 30, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

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Frank Sai-keung Lee

1/30/2019

Date

For and on behalf of Sunrise Memory Corporation



Signature

1/30/2019

Date

Name: NAM KEDGA

Title: operations

ASSIGNMENT

I, Khandker Nazrul QUADER, residing at Santa Clara, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/803,689, filed February 11, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.


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Khandker Nazrul QUADER

2-15-19
Date

For and on behalf of Sunrise Memory Corporation


Signature

2-15-19
Date

Name: NOAM KEDEM
Title: OPERATIONS

ASSIGNMENT

I, Eli HARARI, residing at Saratoga, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/803,689, filed February 11, 2019;

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Eli Harari
Eli HARARI

2.13.19
Date

For and on behalf of Sunrise Memory Corporation

Eli Harari
Signature

2.13.19
Date

Name: ELI HARARI
Title: CEO

ASSIGNMENT

I, Sayeef SALAHUDDIN, residing at Walnut Creek, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/803,689, filed February 11, 2019;

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Sayeef Salahuddin
Sayeef SALAHUDDIN

2.13.2019
Date

For and on behalf of Sunrise Memory Corporation

Noam Keogen
Signature

2-13-2019
Date

Name: NOAM KEOGEN
Title: OPERATIONS

ASSIGNMENT

I, Robert NORMAN, residing at Pendleton, Oregon, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/803,689, filed February 11, 2019;

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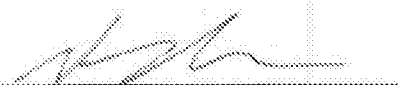
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Robert NORMAN

2/11/2019
Date

For and on behalf of Sunrise Memory Corporation


Signature

2/11/19
Date

Name: NOAM KEDEM
Title: OPERATIONS

ASSIGNMENT

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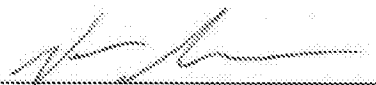
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Siu Lung CHAN

2/11/19
Date

For and on behalf of Sunrise Memory Corporation


Signature

2/11/19
Date

Name: NOAM KEDEM
Title: OPERATIONS

ASSIGNMENT

I, Mehrdad MOFIDI, residing at Los Altos Hills, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/803,689, filed February 11, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.


I also hereby assign and transfer, and hereby agree to assign and transfer, to Assignee all right, title and interest to any and all applications for patent for the Invention throughout the world, including all rights of priority resulting from the filing of the Application or any related application, including but not limited to: the right to file applications and obtain patents, utility models, industrial models and designs for the Invention throughout the world, the right to claim priority from the Application or any related application when filing applications and obtaining patents, utility models, industrial models and designs for the Invention throughout the world.

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Mehrdad MOFIDI

2-11-2019
Date

For and on behalf of Sunrise Memory Corporation


Signature

2/11/19
Date

Name: NOAM KEDEM
Title: OPERATIONS


ASSIGNMENT

I, Frank Sai-keung LEE, residing at San Jose, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/803,689, filed February 11, 2019;

NOW, THEREFORE, for good and valuable consideration; the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

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Frank Sai-keung LEE

Date

2/11/2019

For and on behalf of Sunrise Memory Corporation



Signature

Date

2/14/2019

Name: NGAM KEOBAN

Title: OPERATIONS

ASSIGNMENT

I, Scott Brad HERNER, residing at Lafayette, Colorado, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/843,733, filed May 6, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

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Scott Brad Herner
Scott Brad HERNER

May 10, 2019
Date

For and on behalf of Sunrise Memory Corporation

[Signature]
Signature

May 12 2019
Date

Name: OGAM KEDEM
Title: operations

ASSIGNMENT

I, Christopher J. PETTI, residing at Mountain View, California, am an inventor of the subject matter described and claimed in a provisional patent application entitled "Device with Embedded High-Bandwidth, High-Capacity Memory using Wafer Bonding," (hereinafter referred to as "Application") application serial number 62/843,733, filed May 6, 2019;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

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I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith, and generally do everything possible and necessary to perfect all rights, title and interest hereby assigned and transferred, and hereby agreed to be assigned and transferred, in and to Assignee.




Christopher J. PETTI

May 13 2019

Date

For and on behalf of Sunrise Memory Corporation



Signature

May 12. 2019

Date

Name: NOAM KEDEM
Title: Operations